Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
15	2	("6619859").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:16
L2	646398	u near (shape or shaped or holder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:21
L3	3777	optic\$3 with 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:18
L4	54	(sheet or layer or film) with between with 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:18
L5	1534641	(sheet or layer or film) with between	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:18
L6	57	optic\$3 with 2 with semiconductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:19
L7	16	5 and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:19
L8	17190	u near (shape or shaped) with holder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:23

L9	23	optic.ti,ab. and 8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:21
L10	40	8 and (optic\$3 with (assembly or subassembly)):ti,ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:25
L11	327	bridge and (optic\$3 with (assembly or subassembly)).ti,ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:26
L12	15	(bridge near3 (hold\$4 or cover\$4)) and (optic\$3 with (assembly or subassembly)).ti,ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:30
L13	698736	385/88-92.cc.s and @pd>="20051201"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:31
L14	307	385/88-92.ccls. and @pd>="20051201"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/25 09:31
S1	1419	(385/92).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/07/25 06:15
S2	347.7765	heat or thermal	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/06/10 10:31
S3	714	S1 and S2	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2005/06/10 10:31

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			T	T	T _	T
S53	15429	(semiconductor with laser with device).ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/09 09:25
S54	245	(semiconductor with photodetector with device).ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/09 09:25
S55	13819	(optic\$3 near3 (subassembly or assembly)).ti,ab.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/03/15 09:23
S56	2	("6619859"):PN:	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:19
S57	2263	semiconductor with (optical near module\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:06
S58	12	semiconductor with (optical near module\$1) with purpose	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:08
S59	11	(semiconductor near material) with (optical) with purpose	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:09
S60	10	(semiconductor near material).ab. with (optical) with good	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:12

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S61	115148	optic\$3 near3 (module or device or assembly or subassembly).ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:12
S62	24363	(semiconductor near material).ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:12
S63	255	S61 and S62	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:12
S64	7625	(semiconductor near material) with (purpose of good or providing or provides or useful or preventing or promoting)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:13
S65	22	S63 and S64	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:13
S66	27	laser near device.ti. and S64	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:19
S67	26	photodiode.ti. and S64	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:34
S68	2	("20040151443").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/03/15 10:34